

UNITED STATES PATENT AND TRADEMARK OFFICE

UNITED STATES DEPARTMENT OF COMMERCE United States Patent and Trademark Office Address: COMMISSIONER FOR PATENTS P.O. Box 1450 Alexandria, Virginia 22313-1450 www.uspto.gov

APPLICATION NO.	FI	LING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
09/483,737 01/14/2000		Hansjorg Reichert	GR-97-P-1903	8769	
24131	7590	09/09/2005		EXAMINER	
LERNER A P O BOX 24		EENBERG, PA	SEFER, AHMED N		
HOLLYWO	OD, FL	33022-2480		ART UNIT	PAPER NUMBER
				2826	

DATE MAILED: 09/09/2005

Please find below and/or attached an Office communication concerning this application or proceeding.

	Application No.	Applicant(s)
	09/483,737	REICHERT ET AL.
Office Action Summary	Examiner	Art Unit
	A. Sefer	2826
The MAILING DATE of this communication ap Period for Reply	pears on the cover sheet with the c	correspondence address
A SHORTENED STATUTORY PERIOD FOR REPL THE MAILING DATE OF THIS COMMUNICATION. - Extensions of time may be available under the provisions of 37 CFR 1. after SIX (6) MONTHS from the mailing date of this communication. - If the period for reply specified above is less than thirty (30) days, a rep - If NO period for reply is specified above, the maximum statutory period - Failure to reply within the set or extended period for reply will, by statute Any reply received by the Office later than three months after the mailine - earned patent term adjustment. See 37 CFR 1.704(b).	136(a). In no event, however, may a reply be tin ly within the statutory minimum of thirty (30) day will apply and will expire SIX (6) MONTHS from e, cause the application to become ABANDONE	nely filed s will be considered timely. the mailing date of this communication. D (35 U.S.C. § 133).
Status		
1) Responsive to communication(s) filed on <u>07 J</u>	<u>une 2005</u> .	
2a)⊠ This action is FINAL . 2b)□ This	s action is non-final.	
3) Since this application is in condition for allowated closed in accordance with the practice under the condition of the condition.		
Disposition of Claims		∠
 4) ☐ Claim(s) 1.9.10 and 15 is/are pending in the a 4a) Of the above claim(s) 1.9 and 10 is/are wit 5) ☐ Claim(s) is/are allowed. 6) ☐ Claim(s) 15 is/are rejected. 7) ☐ Claim(s) is/are objected to. 8) ☐ Claim(s) are subject to restriction and/or 	hdrawn from consideration. NATE SUPERVISOR TECKNOL	HADE EVANIMEN OF CENTER 2800
Application Papers		
9) The specification is objected to by the Examine	er.	
10)☐ The drawing(s) filed on is/are: a)☐ acc	cepted or b) \square objected to by the $\mathfrak k$	Examiner.
Applicant may not request that any objection to the		` '
Replacement drawing sheet(s) including the correct 11) The oath or declaration is objected to by the Ex	· · · · · · · · · · · · · · · · · · ·	* *
Priority under 35 U.S.C. § 119		
 12) Acknowledgment is made of a claim for foreign a) All b) Some * c) None of: 1. Certified copies of the priority document 2. Certified copies of the priority document 3. Copies of the certified copies of the priority application from the International Burea * See the attached detailed Office action for a list 	ts have been received. Its have been received in Applicationity documents have been received u (PCT Rule 17.2(a)).	on No ed in this National Stage
Attachment(s)		
1) X Notice of References Cited (PTO-892)	4) Interview Summary	(PTO-413)
2) Notice of Draftsperson's Patent Drawing Review (PTO-948) B) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08) Paper No(s)/Mail Date	Paper No(s)/Mail Da	

Application/Control Number: 09/483,737 Page 2

Art Unit: 2826

DETAILED ACTION

1. In view of the appeal brief filed on 6/7/2005, PROSECUTION IS HEREBY REOPENED. A new ground of rejection is set forth below.

To avoid abandonment of the application, appellant must exercise one of the following two options:

- (1) file a reply under 37 CFR 1.111 (if this Office action is non-final) or a reply under 37 CFR 1.113 (if this Office action is final); or,
 - (2) request reinstatement of the appeal.

If reinstatement of the appeal is requested, such request must be accompanied by a supplemental appeal brief, but no new amendments, affidavits (37 CFR 1.130, 1.131 or 1.132) or other evidence are permitted. See 37 CFR 1.193(b)(2).

Claim Rejections - 35 USC § 103

- 2. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 3. Claim 15 is rejected under 35 U.S.C. 103(a) as being unpatentable over Ishii (JP 6-326210) (of record) in view of Fister et al. ("Fister") WO 88/03705 and Bacon et al. ("Bacon") USPN 5,234,153.

Ishii discloses in fig. 2 a semiconductor component comprising a solder containing at least two components with at least two constituents including a first constituent containing a precious metal and a second constituent being consumed during a soldering operation by one of

Art Unit: 2826

reacting and being dissolved in material which are to be joined; a substrate 40; a chip 1 having a rear side and a diffusion barrier 7a; said semiconductor chip being secured at said rear side to a substrate 40 by a solder containing gold and tin solder 8 and said solder having a hypereutectic concentration containing gold-tin (AuSn) with a hypereutectic Sn concentration and containing a gold-tin compound (AuSn) having a composition which falls within the range recited in the claim; and said a semiconductor chip being secured to said substrate by one of alloying and brazing using said solder but lacks anticipation of an adhesive or diffusion barrier provided on said rear side of semiconductor chip or solder thickness.

Fister discloses in figs. 1-5 a semiconductor component comprising a solder 18 containing at least two components with at least two constituents including a first constituent containing a precious metal and a second constituent; a substrate 14; and a semiconductor chip 12 having a rear side and adhesive 19 provided on said rear side; and said semiconductor chip being secured at said rear side to said substrate by one of alloying and brazing using said solder to form chip-substrate connection by said solder.

Bacon teaches (see col. 1 lines 50-63 and claim 7) the advantage of using a thin gold-tin compound solder.

Since Fister and Bacon are both from the same field of endeavor, semiconductor die, the teachings of Fister and Bacon would have been recognized in Ishii's pertinent art. Therefore, in view of Fister's teachings, one having an ordinary skill in the art at the time the invention was made would be motivated to modify Ishii's device by incorporating a diffusion barrier on a rear side of a semiconductor chip since that would dissipate thermal cycling stresses as taught by

Art Unit: 2826

Fister. It would have been obvious to incorporate a thin solder, since that would provide a better thermal conductance as taught by Bacon.

Conclusion

4. Applicant's amendment necessitated the new ground(s) of rejection presented in this Office action. Accordingly, **THIS ACTION IS MADE FINAL**. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the date of this final action.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to A. Sefer whose telephone number is (571) 272-1921.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Nathan Flynn can be reached on (571) 272-1915.

Application/Control Number: 09/483,737

Art Unit: 2826

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Page 5

ANS

August 31, 2005

MATHAN J. STAN

SUPERVISORY PATENT EXAMINER TECHNOLOGY CENTER 2800